

MKP Film Capacitor

Material Data Sheet

Product Class	Motor run round B32327x / B32329x	
Date	18/11/2019	8252
IMDS ID if available	NA	5.LF (2.1 p. second. co. co. co. co. co. co. co. co. co. co
Version	5.02.1a (03/2019)	A Spanish

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Thermoplastic	2A	PP	100	9003-07-0	30.4	
	Light Metal	1B	Al	4	7429-90-5		
	Heavy Metal	1C	Zn	94	7440-66-6	11.7	
			others*):	2	Not available	1	
Encapsulation	Thermoplastic	2A	PA 66 or	100 or	32131-17-2 or		
			PP	89	9010-79-1		
			Brominated flame retardant	5	21850-44-2	13.3	
			Sb2O3	3	1309-64-4		
			Other	3			
	Duromer	2D	Epoxy resin or PU resin	100	Not available	26.6	
Termination	Heavy Metal	1C	Sn	99.3	7440-31-5	0.0	
			Cu	0.7	7440-50-8	0.9	
	Heavy Metals	1C	Cu	100	7440-50-8	4.1	
	Thermoplastic	2A	PVC	100	9002-86-2	12.2	
	Heavy Metals	1C	Brass	100	7440-31-5	0.8	
			•		Sum in total:	100	

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sizes [.DxH.]	weight range [.g]	part numbers	sizes [.DxH.]	weight range [.g]	part numbers	sizes []	weight range []	part numbers
25x56	33		35x60	35				
30x56	26		40x95	120				
30x60	45		40x98	130				
30x62	50		50x120	272				
35x59	61							
35x72	39							
40x98	120							

Not part of a Product Class

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^{*)} others: .(not declarable or prohibited substances acc. GADSL)

Important remarks:

- The declaration limit is 0.1% as defined by IEC PAS 61906. Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated.
- This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

^{**)} typical mass percentage of substance



ROHS - Exemptions for the Product Class / Product according to Annex III: (valid not valid) | no exemptions; | Exemption 6 (a): | Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight; | Lead as an alloying element in aluminium containing up to 0,4 % lead by weight; | Lead as an alloying element in aluminium containing up to 0,4 % lead by weight; | Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead); | Exemption 7 (c)-l: | Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound; | Exemption 7 (c)-li: | Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC; | Exemption 15: | Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;